



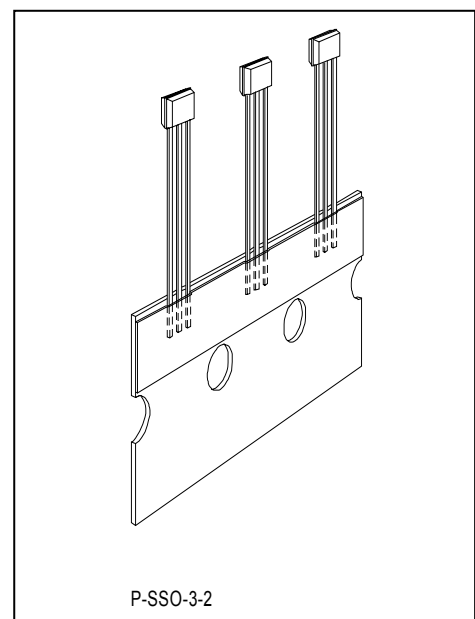
High Precision Hall-Effect Switch

TLE4906L

Data Sheet Version 1.0
2003-11-20

Features

- 2.7V to 24V supply voltage operation
- Operation from unregulated power supply
- High sensitivity and high stability of the magnetic switching points
- High resistance to mechanical stress by Active Error Compensation
- Reverse battery protection (-18V)
- Superior temperature stability
- Peak temperatures up to 195°C without damage
- Low jitter (typ. 1µs)
- High ESD performance (±6kV HBM)
- Digital output signal
- Unipolar version
- Leaded package P-SSO-3-2



Type	Ordering Code	Package
TLE4906L	Q62705-K694	P-SSO-3-2

Functional Description

The TLE4906L is an integrated circuit Hall-effect sensor designed specifically for highly accurate automotive and industrial applications. Precise magnetic switching points and high temperature stability are achieved by active compensation circuits and chopper techniques on chip.

Circuit Description

The chopped Hall IC Switch comprises a Hall probe, bias generator, compensation circuits, oscillator and output transistor.

The bias generator provides currents for the Hall probe and the active circuits. Compensation circuits stabilize the temperature behavior and reduce technology variations.

The Active Error Compensation rejects offsets in signal stages and the influence of mechanical stress to the Hall probe caused by molding and soldering processes and other thermal stresses in the package. This chopper technique together with the threshold generator and the comparator ensure high accurate magnetic switching points.

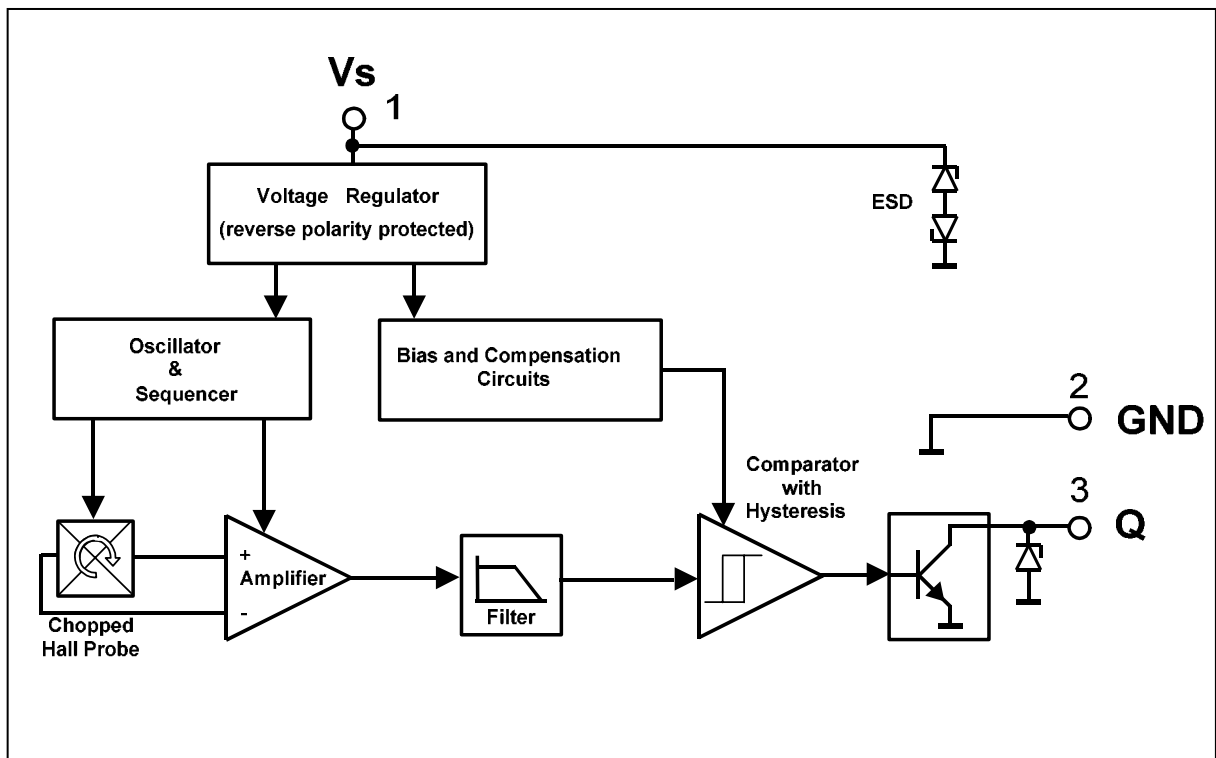


Figure 1: Block Diagram

Pin Configurations

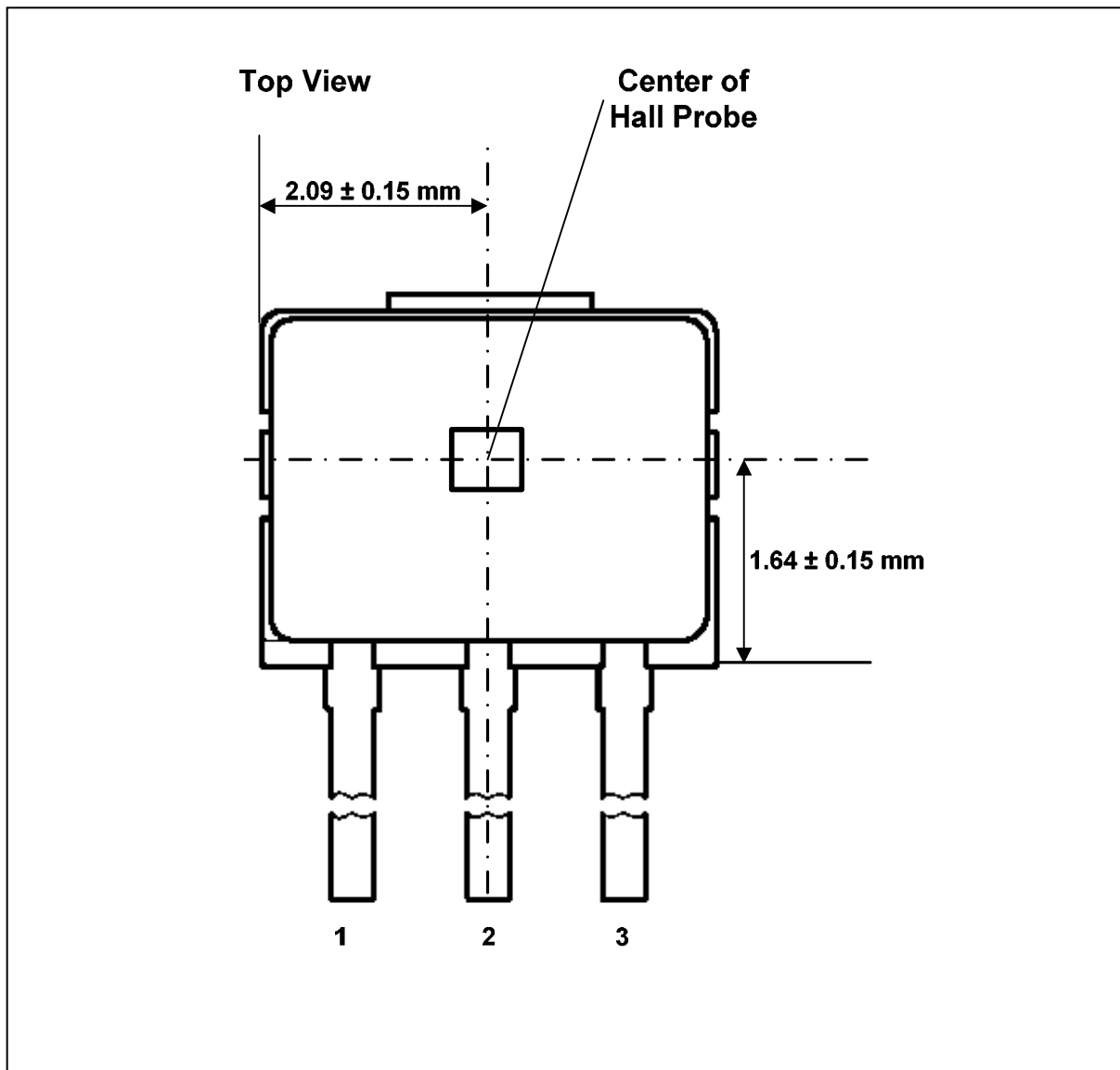


Figure 2: Pin Configuration

Pin Definition and Functions

Pin	Symbol	Function
1	V_s	Supply voltage
2	GND	Ground
3	Q	Output

Absolute Maximum Ratings

$T_j = -40$ to 150°C

Parameter	Symbol	min.	max.	Unit	Conditions
Supply Voltage	V_S	-18 -18 -18	18 24 26	V	for 1h, $R_S \geq 200\ \Omega$ for 5min, $R_S \geq 200\ \Omega$
Supply Current through protection device	I_S	-50	+50	mA	
Output Voltage	V_Q	-0.7 -0.7	18 26	V	for 5 min @ 1.2 k Ω pull up
Continuous Output Current	I_Q	-50	+50	mA	
Junction Temperature	T_j	-	155 165 175 195	$^{\circ}\text{C}$	for 2000 h (not additive) for 1000 h (not additive) for 168 h (not additive) for 3x1 h (additive)
Storage Temperature	T_S	-40	150	$^{\circ}\text{C}$	
Magnetic Flux Density	B	-	unlimit.	mT	

Note: Stresses above those listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD Protection

Human Body Model (HBM) tests according to:

EOS/ESD Association Standard S5.1-1993 and Mil. Std. 883D method 3015.7

Parameter	Symbol	max.	Unit	Conditions
ESD Voltage	V_{ESD}	± 6	kV	HBM, $R = 1.500\ \Omega$, $C = 100\text{pF}$; $T_A = 25^{\circ}\text{C}$

Operating Range

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Voltage	V_S	2.7	-	18 24 26	V	1h with $R_S \geq 200\ \Omega$ for 5min $R_S \geq 200\ \Omega$
Output Voltage	V_Q	-0.7	-	18	V	
Junction Temperature	T_j	-40	-	150 175	$^{\circ}\text{C}$	for 168 h
Output Current	I_Q	0	-	20	mA	

AC/DC Characteristics

over operating range, unless otherwise specified. Typical values correspond to $V_S=12V$ and $T_A=25^\circ C$.

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Current	I_S	2	4	6	mA	$V_S = 2.7V \dots 18V$
Reverse Current	I_{SR}	0	0.2	1	mA	$V_S = -18V$
Output Saturation Voltage	V_{QSAT}	-	0.3	0.6	V	$I_Q = 20mA$
Output Leakage Current	I_{QLEAK}	-	0.05	10	μA	for $V_Q=18V$
Output Fall Time	t_f	-	0.02	1	μs	$R_L = 1.2 k\Omega$; $C_L=50pF$
Output Rise Time	t_r	-	0.4	1	μs	$R_L = 1.2 k\Omega$; $C_L=50pF$
Chopper Frequency	f_{OSC}	-	320	-	kHz	
Switching Frequency	f_{SW}	0	-	15 ¹⁾	kHz	
Delay Time ²⁾	t_d	-	13	-	μs	
Output Jitter ³⁾	t_{QJ}	-	1	-	μs_{RMS}	B = Square-Wave Signal 1kHz
Repeatability of magnetic thresholds ⁴⁾	B_{REP}	-	20	-	μT_{RMS}	$\Delta B/\Delta t > 12mT/ms$
Power-On Time ⁵⁾	t_{PON}	-	13	-	μs	$V_S \geq 2.7V$
Thermal Resistance ⁶⁾ P-SSO-3-2	R_{thJA}	-	-	190	K/W	

¹⁾ To operate the sensor at the max. switching frequency, the value of the magnetic signal amplitude must be 1.4 times higher than for static fields. This is due to the -3dB corner frequency of the low pass filter in the signal path.

²⁾ Systematic delay between magnetic threshold reached and output switching.

³⁾ Jitter is the unpredictable deviation of the output switching delay.

⁴⁾ B_{REP} is equivalent to the noise constant.

⁵⁾ Time from applying $V_S \geq 2.7V$ to the sensor until the output state is valid.

⁶⁾ Thermal resistance from junction to ambient.

e.g.: $V_S=12.0V$, $I_{S_typ}=4mA$, $V_{QSAT_typ}=0.3V$, $I_Q=20mA \Rightarrow$ Power Dissipation $P_{dis}=54.0mW$.

In $T_A = T_j - (R_{thJA} \cdot P_{dis}) = 175^\circ C - (190 K/W \cdot 0.054 W) \Rightarrow T_A = 164.7^\circ C$

Magnetic Characteristics

over operating range, unless otherwise specified. Typical values correspond to $V_S=12V$.

Parameter	Symbol	Tj [°C]	min.	typ.	max.	Unit	Conditions
Operate Point TLE4906L	B_{OP}	-40 25 150	6.7 6.5 6.2	10.3 10.0 9.5	13.9 13.5 12.9	mT	
Release Point TLE4906L	B_{RP}	-40 25 150	5.2 5.0 4.7	8.7 8.5 8.1	12.3 12.0 11.4	mT	
Hysteresis TLE4906L	B_{HYS}	-40 25 150	- 0.7 -	- 1.5 -	- 3.0 -	mT	
Temperature Compensation of Magnetic Thresholds	TC	-	-	-350	-	ppm/°C	

Positive magnetic fields related with south pole of magnet to the branded side of package.

Note: Typical characteristics specify mean values expected over the production spread.

Timing Diagram

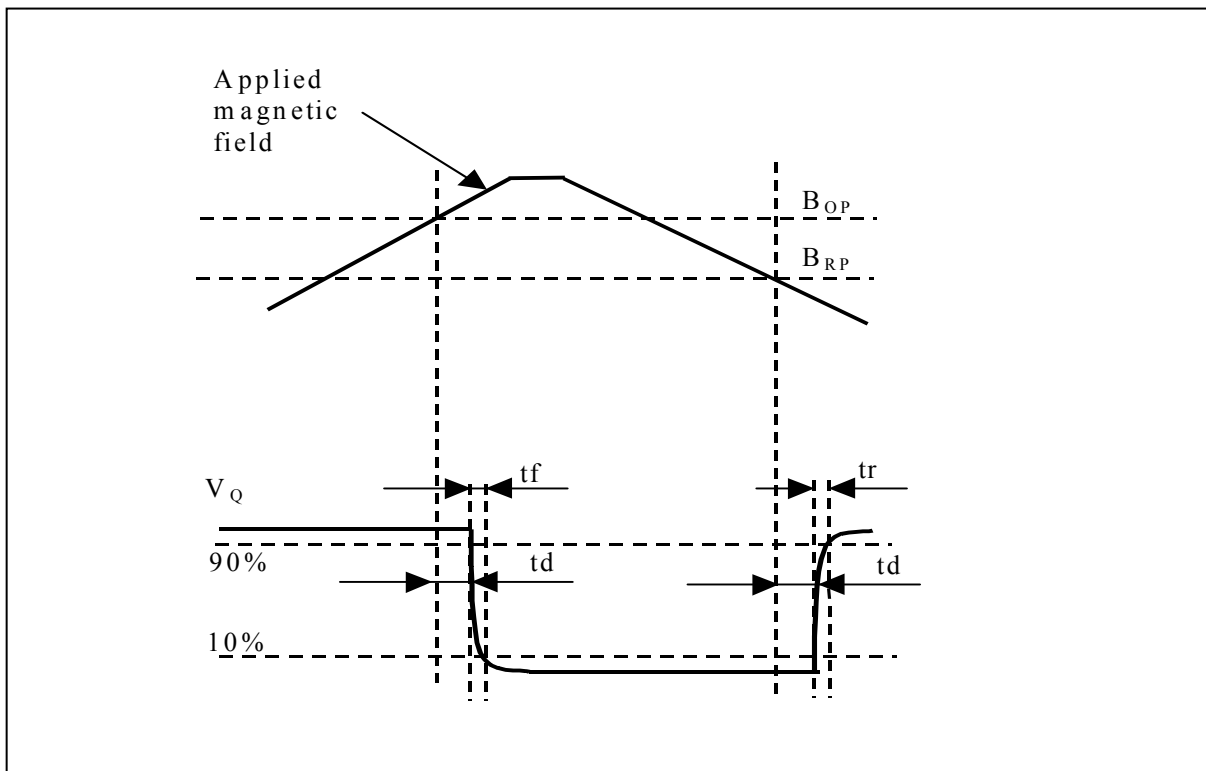


Figure 3: Timing Definition

Technical drawing of a mechanical assembly, showing a side view and a cross-sectional view.

Side View Dimensions:

- Top horizontal dimensions: 4.06 ± 0.08 , 4.19 ± 0.05 , 12.7 ± 1 , 1.9 MAX. , 0.15 MAX.
- Vertical dimensions on the left: 3 ± 0.06 , 3.29 ± 0.08 , (0.25)
- Horizontal dimensions at the bottom: 6.35 ± 0.4 , 12.7 ± 0.3 , 4 ± 0.3
- Vertical dimensions on the right: 23.8 ± 0.5 , 38 MAX.
- Internal dimensions: 1.27 ± 0.25 , 0.4 ± 0.05 , $9^{+0.75}_{-0.5}$
- Top feature: $0.8 \times 45^\circ$
- Feature labels: 1, 3

Cross-sectional View Dimensions:

- Top horizontal dimensions: 1.52 ± 0.05 , 0.79
- Vertical dimensions on the left: $0.35 \times 45^\circ$, 18 ± 0.5
- Horizontal dimensions on the right: $0.2^{+0.1}$, 1 , 1
- Internal dimensions: 6 ± 0.5 , $0.25^{+0.15}_{-0.15}$
- Bottom horizontal dimensions: 0.5 ± 0.1
- Labels: Adhesive Tape, Tape

The diagram shows a side view of the P-SSO-3-2 package. A dimension line labeled 'd' indicates the distance from the top surface of the package to the center of the chip. The chip is labeled 'Branded Side'. The package is labeled 'Hall-Probe'.

d : Distance chip to upper side of IC
P-SSO-3-2 : 0.57 ± 0.08 mm

2003-11-20

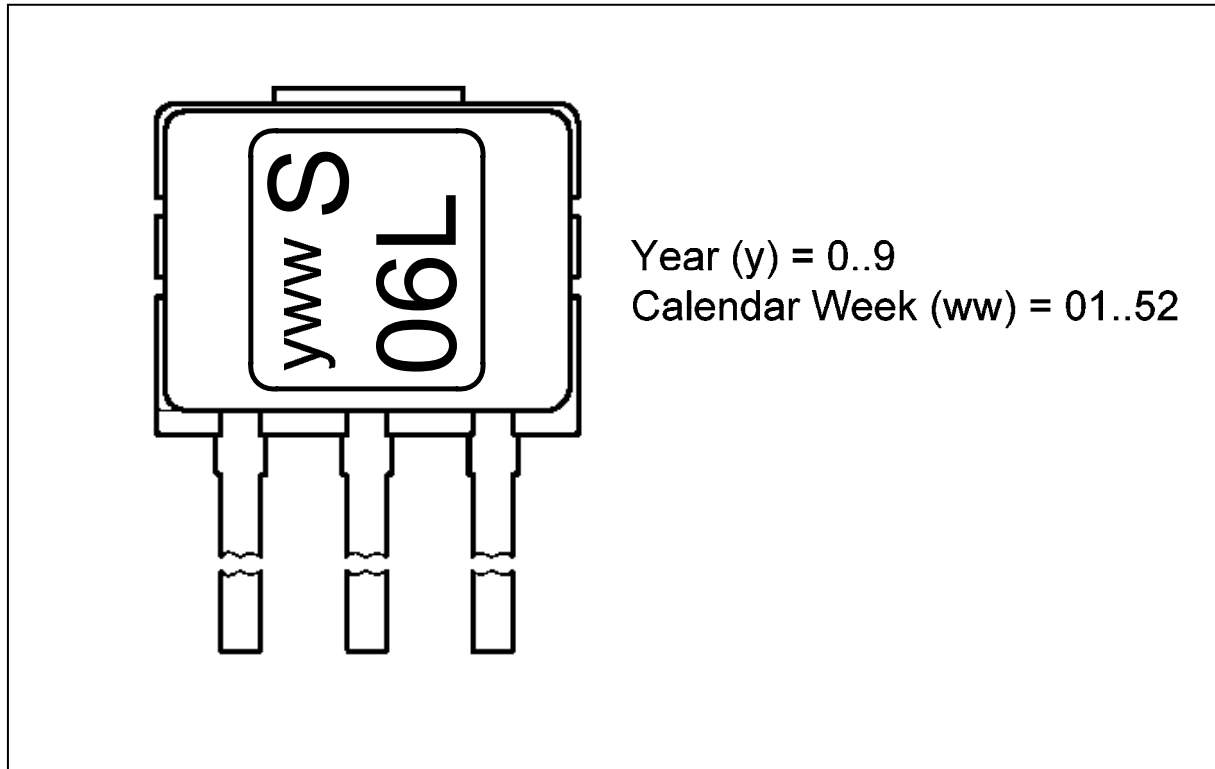


Figure 6: Marking

TLE4906L	
Revision History:	Version 1.0
2003-11-20	
Previous Version:	
Page	Subjects (major changes since last revision)

For questions on technology, delivery and prices please contact the Infineon Technologies Offices in Germany or the Infineon Technologies Companies and Representatives worldwide: see our webpage at <http://www.infineon.com>

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all?

Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to:

feedback.sensors@infineon.com

Edition 2001-02-22

Published by Infineon Technologies AG

St.-Martin-Strasse 53

D-81541 München

© Infineon Technologies AG 2000

All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide (see address list).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.